

FIG. 2A (PRIOR ART)

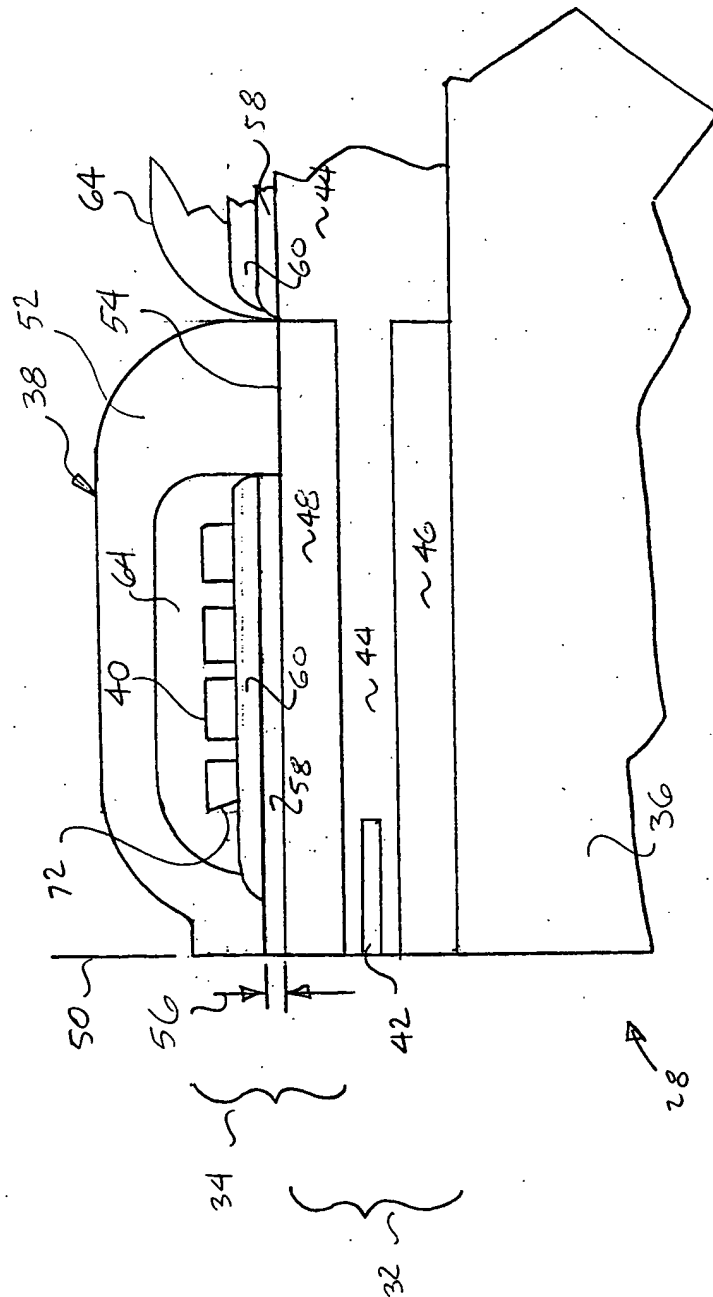


FIG 2B

FIG 2C (PRIOR ART)

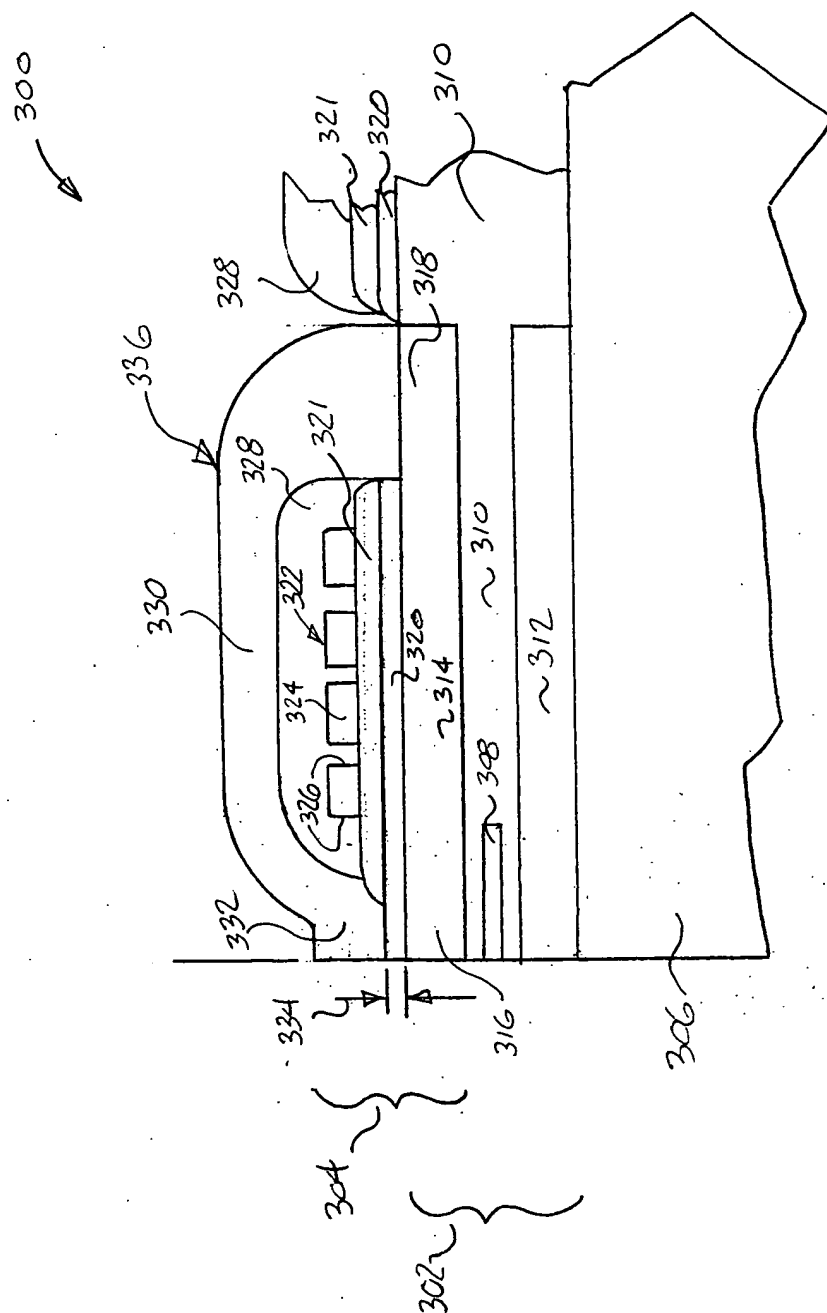


FIG. 3

400



FORM FIRST POLE



402

DEPOSIT WRITE GAP  
MATERIAL LAYER

404

DEPOSIT FIRST INSULATION  
LAYER

406

DEPOSIT COIL SEED LAYER

408

DEPOSIT COIL MASK LAYER

410

FORM COIL RECESS AND  
BUFFER TRENCHES

412

POST DEVELOP BAKE

414

PLATE COIL

416

LIFT OFF MASK

418

FORM COIL INSULATION LAYER

420

FORM SECON POLE

422

FIGURE 4

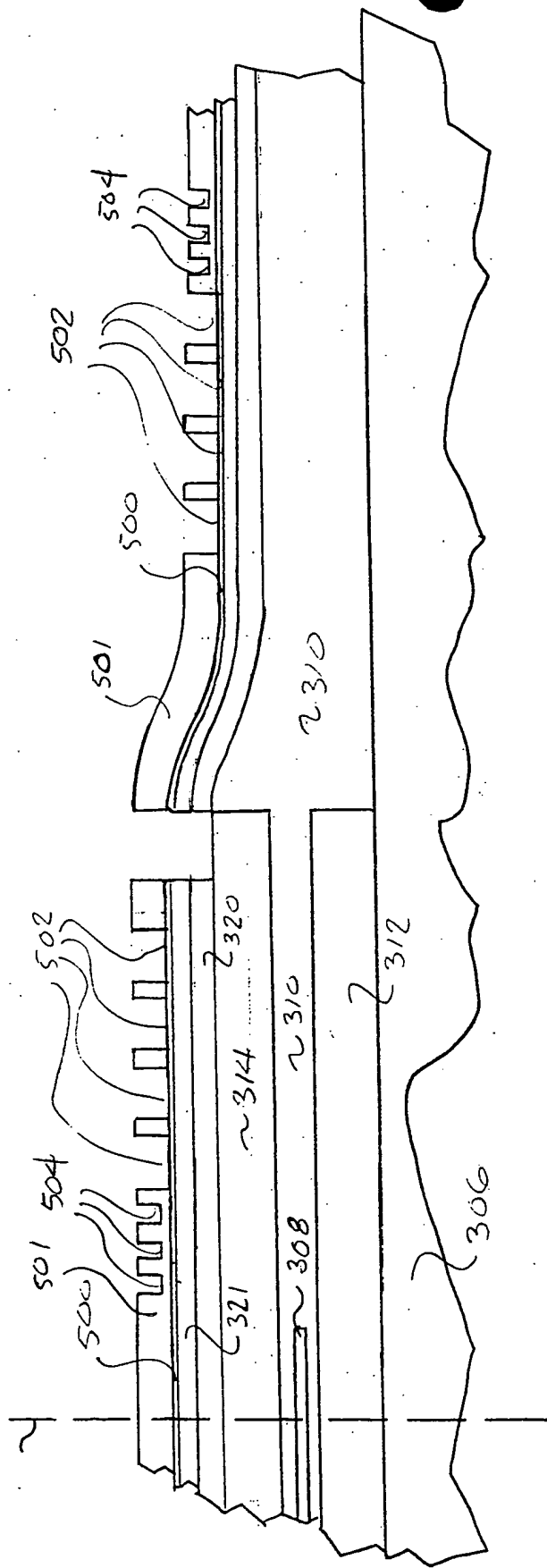


FIG. 5